



12-04-00

A

## PATENT

Docket No. JCLA6224Date: 12-1-2000

Page 1

**ASSISTANT COMMISSIONER FOR PATENTS  
WASHINGTON, D.C. 20231  
ATTENTION: APPLICATION BRANCH**

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Ching-Yu Chang; I-Pien Wu

For: HOT PLATE COOLING SYSTEM

Enclosed are:

- Specification 9 pages.
- 2 Sheets of drawings
- Recordation Form Cover sheet with 2 pages assignment.
- A certified copy of Taiwan Patent Application No.    dated
- SIGNED** declaration and power of attorney.
- Return Prepaid postcard.

---

**CLAIMS AS FILED**

FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$710.00	\$710.00
Total Claims	14	— 20 = 0	\$18.00	\$0.00
Independent Claims	2	— 3 = 0	\$80.00	\$0.00
If application contains any multiple dependent claim(s), then add			\$270.00	\$0.00
<b>TOTAL FILING FEE</b>				<b>\$710.00</b>

---

- A check in the amount of \$710.00 cover the filing fee is enclosed.
- A check in the amount of \$40.00 to cover the assignment recording fee.
- A duplicate copy of this sheet is enclosed.

Jiawei Huang

Registration No. 43,330

**J.C. PATENTS, INC.**  
1340 REYNOLDS AVE., SUITE 114  
IRVINE, CALIFORNIA 92614  
(949) 660-0761  
FAX: (949) 660-0809

Assistant Commissioner for Patents  
Washington, D.C. 20231

**CERTIFICATE OF MAILING BY "EXPRESS MAIL"**

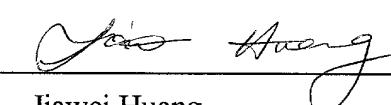
**Docket No.** : **JCLA6224**  
**Applicant(s)** : **Ching-Yu Chang; I-Pien Wu**  
**For** : **HOT PLATE COOLING SYSTEM**  
"Express Mail" : **EL608225791US**  
**Mailing Label No.**

**Date of Deposit** : *December 1, 2000*

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 9 pages, 2 sheets of drawings; SIGNED Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and Assignment 3 pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

  
\_\_\_\_\_  
Jiawei Huang